

## HX426C13SB/4

4GB 512M x 64-Bit

DDR4-2666 CL13 288-Pin DIMM



### DESCRIPTION

HyperX HX426C13SB/4 is a 512M x 64-bit (4GB) DDR4-2666 CL13 SDRAM (Synchronous DRAM) 1Rx8, memory module, based on eight 512M x 8-bit FBGA components. Each module supports Intel® XMP (Extreme Memory Profiles). Each module has been tested to run at DDR4-2666 at a low latency timing of 13-14-14 at 1.35V. The SPDs are programmed to JEDEC standard latency DDR4-2133 timing of 15-15-15 at 1.2V. Each 288-pin DIMM uses gold contact fingers. The JEDEC standard electrical and mechanical specifications are as follows:

### XMP TIMING PARAMETERS

- JEDEC: DDR4-2133 CL15-15-15 @1.2V
- XMP Profile #1: DDR4-2666 CL13-14-14 @1.35V
- XMP Profile #2: DDR4-2400 CL13-13-13 @1.35V

### SPECIFICATIONS

CL(IDD)	15 cycles
Row Cycle Time (tRCmin)	46.5ns (min.)
Refresh to Active/Refresh Command Time (tRFCmin)	260ns (min.)
Row Active Time (tRASmin)	33ns (min.)
Maximum Operating Power	TBD W*
UL Rating	94 V - 0
Operating Temperature	0° C to +85° C
Storage Temperature	-55° C to +100° C

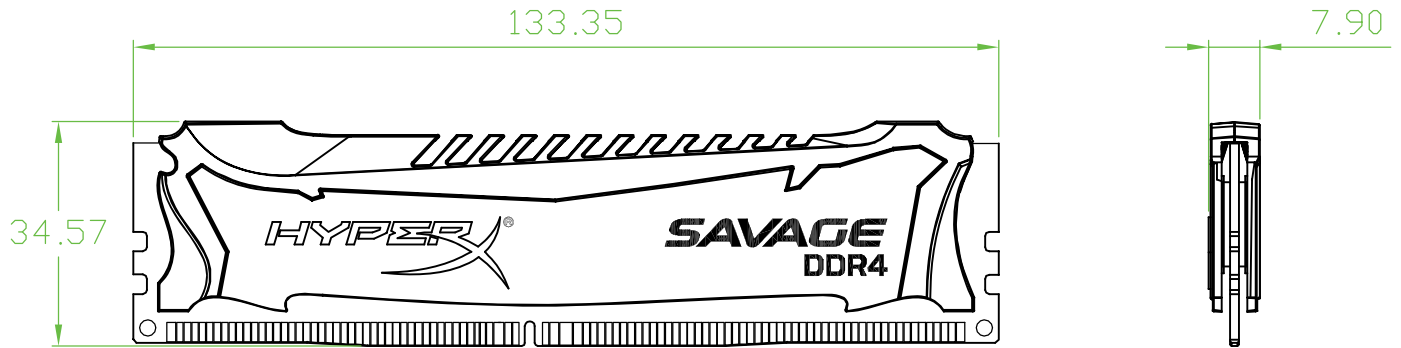
\*Power will vary depending on the SDRAM used.

### FEATURES

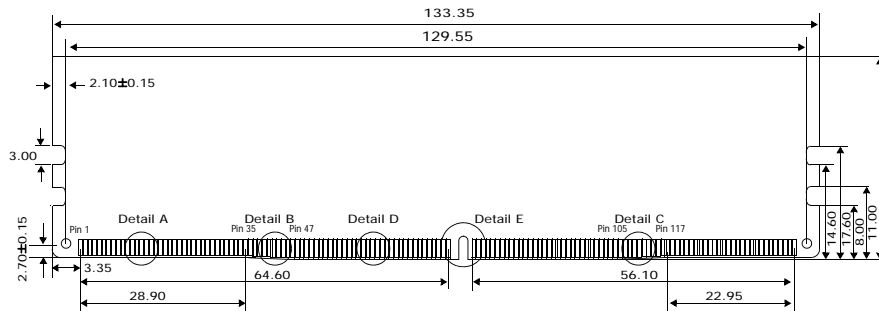
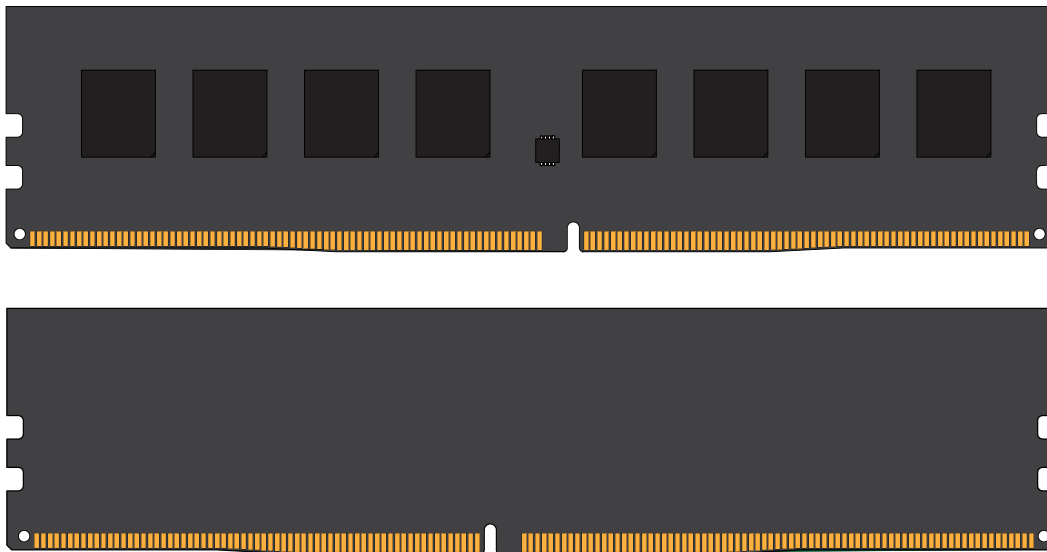
- Power Supply: VDD = 1.2V Typical
- VDDQ = 1.2V Typical
- VPP - 2.5V Typical
- VDDSPD = 2.25V to 3.6V
- On-Die termination (ODT)
- 16 internal banks; 4 groups of 4 banks each
- Bi-Directional Differential Data Strobe
- 8 bit pre-fetch
- Burst Length (BL) switch on-the-fly BL8 or BC4(Burst Chop)
- Height 1.36" (34.57mm)

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### MODULE WITH HEAT SPREADER



### MODULE DIMENSIONS



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